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December 2013

FQB8N90C

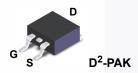
N-Channel QFET[®] MOSFET 900 V, 6.3 A, 1.9 Ω

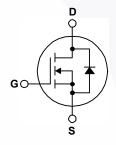
Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switch mode power supplies.

Features

- 6.3 A, 900 V, $R_{DS(on)}$ = 1.9 Ω (Max.) @ V_{GS} = 10 V
- Low Gate Charge (Typ. 35 nC)
- Low C_{rss} (Typ. 12 pF)
- · Fast Switching
- · 100% Avalanche Tested
- · Improved dv/dt Capability





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol	Parameter	FQB8N90CTM	Unit
V _{DSS}	Drain-Source Voltage	900	V
I _D	Drain Current - Continuous (T _C = 25°C)	6.3	Α
	- Continuous (T _C = 100°C)	3.8	Α
I _{DM}	Drain Current - Pulsed (Note 1)	25	Α
V_{GSS}	Gate-Source Voltage	± 30	V
E _{AS}	Single Pulsed Avalanche Energy (Note 2)	850	mJ
I _{AR}	Avalanche Current (Note 1)	6.3	Α
E _{AR}	Repetitive Avalanche Energy (Note 1)	17.1	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)	4.0	V/ns
P_{D}	Power Dissipation (T _C = 25°C)	171	W
	- Derate Above 25°C	1.37	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range	-55 to +150	°C
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds.	300	°C

Thermal Characteristics

Symbol	Parameter FQB8N90CTM			
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case, Max.	0.73		
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient, Max. 40			

Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FQB8N90CTM	FQB8N90C	D ² -PAK	Tape and Reel	330 mm	24 mm	800 untis

Electrical Characteristics

 T_C = 25°C unless otherwise noted.

Symbol	Parameter	Test Conditions		Тур.	Max.	Unit
Off Cha	racteristics					
3V _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	900			V
ΔBV _{DSS} ΔΤ _J	Breakdown Voltage Temperature Coefficient	I _D = 250 μA, Referenced to 25°C		0.95		V/°C
DSS	Zana Cata Valtana Brain Current	V _{DS} = 900 V, V _{GS} = 0 V			10	μА
Zero Gate Vo	Zero Gate Voltage Drain Current	V _{DS} = 720 V, T _C = 125°C			100	μА
GSSF	Gate-Body Leakage Current, Forward	V _{GS} = 30 V, V _{DS} = 0 V			100	nA
GSSR	Gate-Body Leakage Current, Reverse	V _{GS} = -30 V, V _{DS} = 0 V			-100	nA
On Cha	racteristics					
/ _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	3.0		5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10 V, I _D = 3.15 A		1.6	1.9	Ω
J _{FS}	Forward Transconductance	V _{DS} = 50 V, I _D = 3.15 A		5.5		S
Ovnami	ic Characteristics					
Piss	Input Capacitance	V _{DS} = 25 V, V _{GS} = 0 V,		1600	2080	pF
Poss	Output Capacitance	f = 1.0 MHz		130	170	pF
rss	Reverse Transfer Capacitance			12	15	pF
Switchi	na Characteristics					
	ng Characteristics Turn-On Delay Time			40	90	ns
d(on)	Turn-On Rise Time	$V_{DD} = 450 \text{ V}, I_D = 8 \text{ A},$		110	230	ns
	Turn-Off Delay Time	V_{GS} = 10 V, R_G = 25 Ω		70	150	ns
d(off)	Turn-Off Fall Time	(Note 4)		70	150	ns
Q_{g}	Total Gate Charge	V _{DS} = 720 V, I _D = 8 A, V _{GS} = 10 V		35	45	nC
Q _{gs}	Gate-Source Charge			10		nC
ogg Q _{gd}	Gate-Drain Charge	(Note 4)		14		nC
gu						
	ource Diode Characteristics and Ma				0.0	_
						A
					_	A
						V
	· · · · · · · · · · · · · · · · · · ·					ns uC
Drain-S s sm /sp rr	Maximum Continuous Drain-Source Diode Forward Maximum Pulsed Drain-Source Diode Forward Drain-Source Diode Forward Voltage Reverse Recovery Time Reverse Recovery Charge	rward Current		 530 5.8		6.3 25 1.4

Notes:

^{1.} Repetitive rating : pulse-width limited by maximum junction temperature.

^{2.} L = 40 mH, I_{AS} = 6.3 A, V_{DD} = 50 V, R_G = 25 Ω , starting T_J = 25°C.

^{3.} $I_{SD} \le 8$ A, di/dt ≤ 200 A/ μ s, $V_{DD} \le BV_{DSS}$, starting $T_J = 25$ °C.

^{4.} Essentially independent of operating temperature.

Typical Characteristics

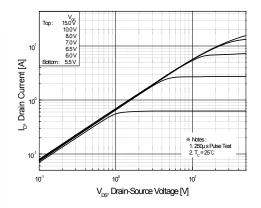


Figure 1. On-Region Characteristics

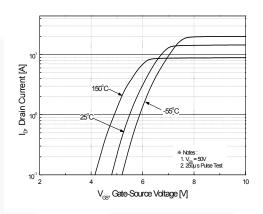


Figure 2. Transfer Characteristics

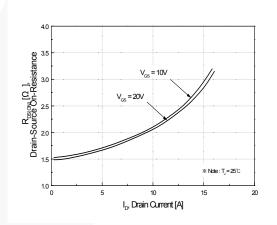


Figure 3. On-Resistance Variation vs
Drain Current and Gate Voltage

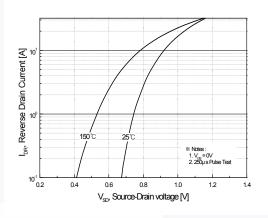


Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature

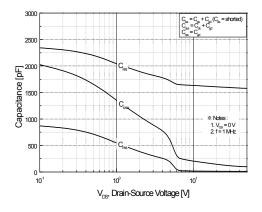


Figure 5. Capacitance Characteristics

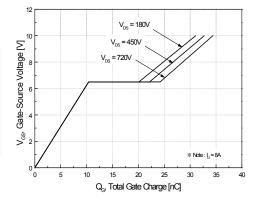


Figure 6. Gate Charge Characteristics

Typical Characteristics (Continued)

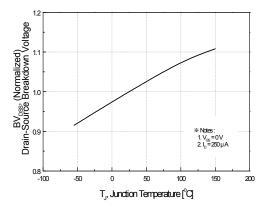


Figure 7. Breakdown Voltage Variation vs Temperature

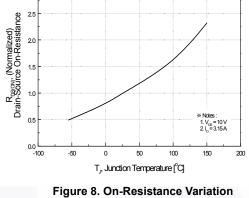


Figure 8. On-Resistance Variation vs Temperature

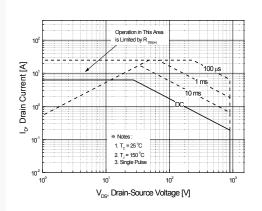


Figure 9. Maximum Safe Operating Area

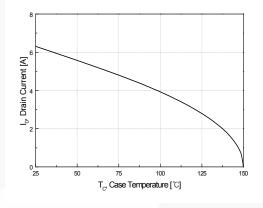


Figure 10. Maximum Drain Current vs Case Temperature

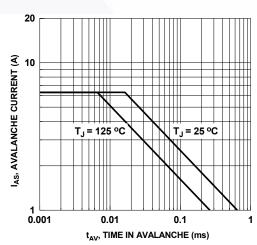


Figure 11. Unclamped Inductive Switching Capability

Typical Characteristics (Continued)

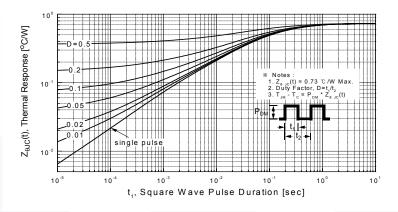


Figure 12. Transient Thermal Response Curve

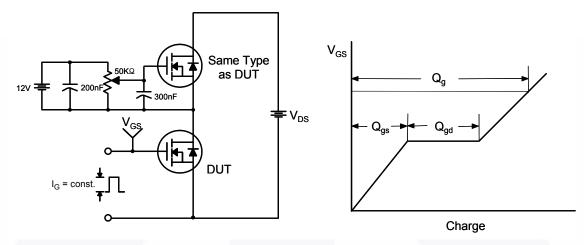


Figure 13. Gate Charge Test Circuit & Waveform

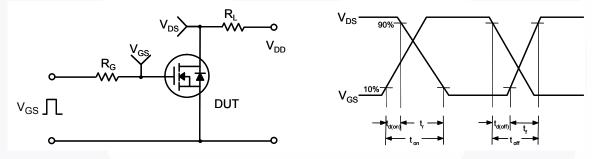


Figure 14. Resistive Switching Test Circuit & Waveforms

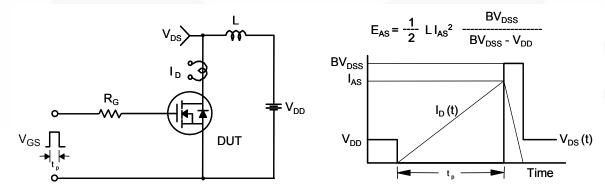


Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms

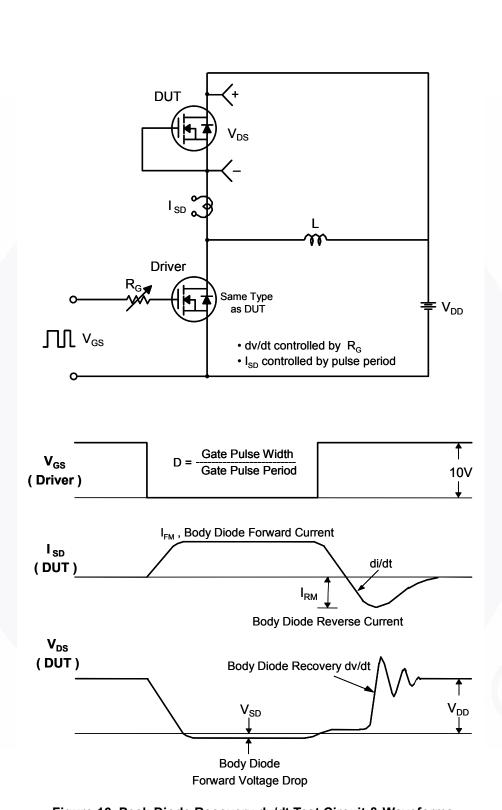


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

Mechanical Dimensions

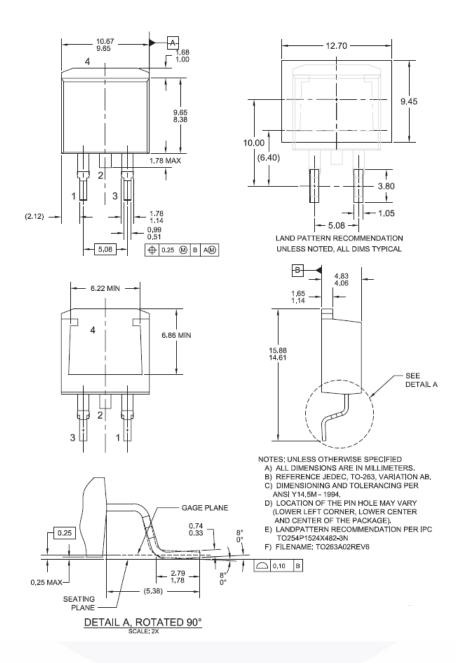


Figure 17. TO263 (D²PAK), Molded, 2-Lead, Surface Mount

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